74HC2G34; 74HCT2G34

Dual buffer gate Rev. 01 — 6 October 2006

**Product data sheet** 

### 1. General description

The 74HC2G34; 74HCT2G34 is a high-speed Si-gate CMOS device.

The 74HC2G34; 74HCT2G34 provides two buffers.

### 2. Features

- Wide supply voltage range from 2.0 V to 6.0 V
- Complies with JEDEC standard no. 7A
- High noise immunity
- ESD protection:
  - HBM JESD22-A114-D exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Low power dissipation
- Balanced propagation delays
- Unlimited input rise and fall times
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

## 3. Ordering information

#### Table 1. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
74HC2G34GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363			
74HC2G34GV	–40 °C to +125 °C	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457			
74HCT2G34GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363			
74HCT2G34GV	–40 °C to +125 °C	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457			

### 4. Marking

Table 2.   Marking	
Type number	Marking code
74HC2G34GW	PA
74HC2G34GV	P34
74HCT2G34GW	UA
74HCT2G34GV	U34



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# 5. Functional diagram



## 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
1A	1	data input
GND	2	ground (0 V)
2A	3	data input
2Y	4	data output
V <sub>CC</sub>	5	supply voltage
1Y	6	data output

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# 7. Functional description

Table 4.	Function	table <sup>[1]</sup>

Input	Output
nA	nY
L	L
Н	Н

[1] H = HIGH voltage level;

L = LOW voltage level.

## 8. Limiting values

#### Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	$V_{I}$ < -0.5 V or $V_{I}$ > $V_{CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
lo	output current	$V_{\rm O}$ = –0.5 V to V_{\rm CC} + 0.5 V	<u>[1]</u> _	±25	mA
I <sub>CC</sub>	supply current		<u>[1]</u> _	+50	mA
I <sub>GND</sub>	ground current		<u>[1]</u> _	-50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation		[2] _	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SC-88 and SC-74 packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

# 9. Recommended operating conditions

#### Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Type 74HC	2G34					
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	°C
t <sub>r</sub>	rise time	except for Schmitt trigger inputs				
		$V_{CC} = 2.0 V$	-	-	1000	ns
		$V_{CC} = 4.5 V$	-	-	500	ns
		$V_{CC} = 6.0 V$	-	-	400	ns
t <sub>f</sub>	fall time	except for Schmitt trigger inputs				
		$V_{CC} = 2.0 V$	-	-	1000	ns
		$V_{CC} = 4.5 V$	-	-	500	ns
		$V_{CC} = 6.0 V$	-	-	400	ns

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Table 6.	Recommended operating conditions continued						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
Type 74H	CT2G34						
V <sub>CC</sub>	supply voltage		4.5	5.0	5.5	V	
VI	input voltage		0	-	V <sub>CC</sub>	V	
Vo	output voltage		0	-	$V_{CC}$	V	
T <sub>amb</sub>	ambient temperature		-40	+25	+125	°C	
t <sub>r</sub>	rise time	except for Schmitt trigger inputs					
		$V_{CC} = 4.5 V$	-	-	500	ns	
t <sub>f</sub>	fall time	except for Schmitt trigger inputs					
		$V_{CC} = 4.5 V$	-	-	500	ns	

# 10. Static characteristics

#### Table 7. Static characteristics for 74HC2G34

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_{amb}$ = 25 °	С					
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	1.2	-	V
		$V_{CC} = 4.5 V$	3.15	2.4	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC} = 2.0 V$	-	0.8	0.5	V
		$V_{CC} = 4.5 V$	-	2.1	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	V
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	V
		$I_{O}$ = -4.0 mA; $V_{CC}$ = 4.5 V	4.18	4.32	-	V
		$I_0 = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.68	5.81	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	V
		$I_O = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$	-	0	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	V
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 4.5 V	-	0.15	0.26	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	V
l <sub>l</sub>	input leakage current	$V_I = GND \text{ or } V_{CC}; V_{CC} = 6.0 \text{ V}$	-	-	±0.1	μA
I <sub>CC</sub>	supply current	$V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 6.0 \text{ V}$	-	-	1.0	μA
CI	input capacitance		-	1.5	-	pF

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Symbol	Parameter	Conditions	Min	Тур	Мах	Uni
T <sub>amb</sub> = -40	°C to +85 °C					
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	-	-	V
		$V_{CC} = 4.5 V$	3.15	-	-	V
	$V_{CC} = 6.0 V$	4.2	-	-	V	
/ <sub>IL</sub>	LOW-level input voltage	$V_{CC} = 2.0 V$	-	-	0.5	V
		$V_{CC} = 4.5 V$	-	-	1.35	V
		$V_{CC} = 6.0 V$	-	-	1.8	V
/ <sub>он</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	-	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	-	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	-	-	V
		$I_0 = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	4.13	-	-	V
		$I_0 = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.63	-	-	V
/ <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 20 \ \mu\text{A}; \ V_{CC} = 2.0 \ V$	-	-	0.1	V
		$I_0 = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$	-	-	0.1	V
		$I_0 = 20 \ \mu\text{A}; \ V_{CC} = 6.0 \ V$	-	-	0.1	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.33	V
		$I_0 = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.33	V
	input leakage current	$V_I = GND \text{ or } V_{CC}; V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μA
CC	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 6.0 \text{ V}$	-	-	10.0	μA
amb = -40	°C to +125 °C					
′ін	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	-	-	V
		$V_{CC} = 4.5 V$	3.15	-	-	V
		$V_{CC} = 6.0 V$	4.2	-	-	V
/IL	LOW-level input voltage	$V_{CC} = 2.0 V$	-	-	0.5	V
		$V_{CC} = 4.5 V$	-	-	1.35	V
		$V_{CC} = 6.0 V$	-	-	1.8	V
′он	HIGH-level output voltage	$V_{I} = V_{IH}$ or $V_{IL}$				
		$I_{\rm O} = -20 \ \mu \text{A}; \ V_{\rm CC} = 2.0 \ \text{V}$	1.9	-	-	V
		$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	-	-	V
		$I_{\rm O} = -20 \ \mu \text{A}; \ V_{\rm CC} = 6.0 \ \text{V}$	5.9	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.7	-	-	V
		$I_{\rm O} = -5.2 \text{ mA}; V_{\rm CC} = 6.0 \text{ V}$	5.2			V

#### Table 7. Static characteristics for 74HC2G34 ... continued

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#### Table 7. Static characteristics for 74HC2G34 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	-	0.1	V
		$I_{O} = 20 \ \mu\text{A}; \ V_{CC} = 6.0 \ \text{V}$	-	-	0.1	V
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 4.5 V	-	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = GND \text{ or } V_{CC}; V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μA
I <sub>CC</sub>	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 6.0 \text{ V}$	-	-	20.0	μA

#### Table 8. Static characteristics for 74HCT2G34

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

	, , ,	0 (0	,			
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
T <sub>amb</sub> = 25	°C					
VIH	HIGH-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	2.0	1.6	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	-	1.2	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	4.18	4.32	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	V
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 4.5 V	-	0.15	0.26	V
l <sub>l</sub>	input leakage current	$V_{I} = GND \text{ or } V_{CC}; V_{CC} = 5.5 \text{ V}$	-	-	±0.1	μΑ
I <sub>CC</sub>	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 5.5 \text{ V}$	-	-	1.0	μA
$\Delta I_{CC}$	additional supply current	$V_{I} = V_{CC} - 2.1 \text{ V};$ $V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}; I_{O} = 0 \text{ A}$	-	-	300	μA
CI	input capacitance		-	1.5	-	pF
T <sub>amb</sub> = -40	0 °C to +85 °C					
VIH	HIGH-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	2.0	-	-	V
VIL	LOW-level input voltage	$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	-	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	4.13	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	-	0.1	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.33	V
I	input leakage current	$V_I = GND \text{ or } V_{CC}; V_{CC} = 5.5 \text{ V}$	-	-	±1.0	μA
I <sub>CC</sub>	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 5.5 \text{ V}$	-	-	10.0	μΑ
$\Delta I_{CC}$	additional supply current	$V_{I} = V_{CC} - 2.1 \text{ V};$ $V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}; I_{O} = 0 \text{ A}$	-	-	375	μΑ
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -40	°C to +125 °C					
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	-	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.7	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$	-	-	0.1	V
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 4.5 V	-	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = GND \text{ or } V_{CC}; V_{CC} = 5.5 \text{ V}$	-	-	±1.0	μA
I <sub>CC</sub>	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 5.5 \text{ V}$	-	-	20.0	μA
$\Delta I_{CC}$	additional supply current	$V_I = V_{CC} - 2.1 V;$ $V_{CC} = 4.5 V \text{ to } 5.5 V; I_O = 0 \text{ A}$	-	-	410	μA

#### Table 8. Static characteristics for 74HCT2G34 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

## **11. Dynamic characteristics**

#### Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6.

Symbol	Parameter	Conditions		25 °C		–40 °C to +125 °C			Unit	
				Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
74HC2G3	34									
t <sub>pd</sub>	propagation delay	nA to nY; see Figure 5	[1]							
		$V_{CC} = 2.0 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	29	75	-	95	125	ns
		$V_{CC} = 4.5 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	9	15	-	19	25	ns
		$V_{CC} = 6.0 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	8	13	-	16	20	ns
tt transition time		nY; see <u>Figure 5</u>	[2]							
		$V_{CC} = 2.0 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	18	75	-	95	125	ns
		$V_{CC} = 4.5 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	6	15	-	19	25	ns
		$V_{CC} = 6.0 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	5	13	-	16	20	ns
C <sub>PD</sub>	power dissipation capacitance	$V_I = GND$ to $V_{CC}$	[3]	-	10	-	-	-	-	pF

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Symbol	Parameter	Conditions		25 °C		–40 °C to +125 °C			Unit	
				Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
74HCT26	34									
t <sub>pd</sub>	t <sub>pd</sub> propagation delay	nA to nY; see Figure 5	[1]							
		$V_{CC} = 4.5 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	10	18	-	23	29	ns
t <sub>t</sub>	transition time	nY; see Figure 5	[2]							
		$V_{CC} = 4.5 \text{ V}; \text{ C}_{L} = 50 \text{ pF}$		-	6	15	-	19	25	ns
C <sub>PD</sub>	power dissipation capacitance	$V_{\text{I}}$ = GND to $V_{\text{CC}}$ – 1.5 V	[3]	-	9	-	-	-	-	pF

#### Table 9. Dynamic characteristics ... continued

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ 

- [2]  $t_t$  is the same as  $t_{TLH}$  and  $t_{THL}$
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}{}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}{}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

 $f_o = output frequency in MHz;$ 

 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of the outputs.

### 12. Waveforms



#### Table 10. Measurement points

Туре	Input	Output		
	V <sub>M</sub>	VI	t <sub>r</sub> = t <sub>f</sub>	V <sub>M</sub>
74HC2G34	$0.5V_{CC}$	GND to V <sub>CC</sub>	6.0 ns	0.5V <sub>CC</sub>
74HCT2G34	1.3 V	GND to 3.0 V	6.0 ns	1.3 V

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#### Table 11. Test data

Туре	Input	Test	
	VI	t <sub>r</sub> , t <sub>f</sub>	t <sub>PHL</sub> , t <sub>PLH</sub>
74HC2G34	GND to V <sub>CC</sub>	6 ns	open
74HCT2G34	GND to 3.0 V	6 ns	open

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## 13. Package outline



### Fig 7. Package outline SOT363 (SC-88)

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### Fig 8. Package outline SOT457 (SC-74)

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# 14. Abbreviations

	Abbreviations
Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
DUT	Device Under Test

# **15. Revision history**

Table 13. Revision	history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT2G34_1	20061006	Product data sheet	-	-

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# 16. Legal information

### 16.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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# 74HC2G34; 74HCT2G34

**Dual buffer gate** 

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